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DOCKET NO. END920020007US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Choi *et al.*

Examiner: Zimmerman, John J.

Serial No.: 10/078,020

Art Unit: 1775

Filed: 2/15/2002

For: LEAD-FREE TIN-SILVER-COPPER ALLOY SOLDER COMPOSITION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

OFFICIAL

AMENDMENT

Sir:

In response to the Office Action mailed October 2, 2003, please amend the above-identified application as follows:

Do Not Print 3/4/04

03/25/2004 TCOLE1 00000001 090457 10078020

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10/078,020

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